IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

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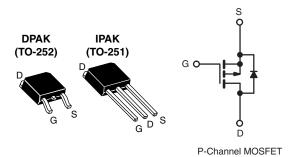
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 100				
$R_{DS(on)}(\Omega)$	V _{GS} = - 10 V 0.60				
Q _g (Max.) (nC)	18				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	9.0				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9120, SiHFR9120)
- Straight Lead (IRFU9120, SiHFU9120)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effictiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION							
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)			
Lead (Pb)-free and Halogen-free	SiHFR9120-GE3	SiHFR9120TR-GE3a	SiHFR9120TRL-GE3 ^a	SiHFU9120-GE3			
Load (Dh) froe	IRFR9120PbF	IRFR9120TRPbF ^a	IRFR9120TRLPbFa	IRFU9120PbF			
Lead (Pb)-free	SiHFR9120-E3	SiHFR9120T-E3a	SiHFR9120TL-E3a	SiHFU9120-E3			

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	- 100	V	
Gate-Source Voltage			V_{GS}	± 20	7	
Continuous Drain Current	\/ at 10.\/	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I-	- 5.6		
Continuous Drain Current	VGS at - 10 V	T _C = 100 °C	Ι _D	- 3.6	Α	
Pulsed Drain Current ^a			I _{DM}	- 22		
Linear Derating Factor				0.33	W/°C	
Linear Derating Factor (PCB Mount)e				0.020] W/ C	
Single Pulse Avalanche Energy ^b			E _{AS}	210	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 5.6	Α	
Repetitive Avalanche Energy ^a			E _{AR}	4.2	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			Б	42	W	
Maximum Power Dissipation (PCB Mount) ^e		P_{D}	2.5	T vv		
Peak Diode Recovery dV/dt ^c			dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) ^d	for	10 s		260		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = -25$ V, starting $T_J = 25$ °C, L = 10 mH, $R_g = 25$ Ω , $I_{AS} = -5.6$ A (see fig. 12).
- c. $I_{SD} \le -6.8 \text{ A}$, $dI/dt \le 110 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).



IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	-	110		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

SPECIFICATIONS (T _J = 25 °C, u	nless otherw	rise noted)					
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = - 250 μA	- 100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.098	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zana Cata Vallana Busin Commant		V _{DS} =	- 100 V, V _{GS} = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 80 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 3.4 A ^b	-	-	0.60	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 50 V, I _D = - 3.4 A	1.5	-	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	390	-	
Output Capacitance	C _{oss}		V _{DS} = - 25 V,	-	170	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	45	-	
Total Gate Charge	Qg			-	-	18	
Gate-Source Charge	Q_{gs}	V _{GS} = - 10 V	$V_{GS} = -10 \text{ V}$ $I_{D} = -6.8 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 ^b		-	3.0	nC
Gate-Drain Charge	Q_{gd}			-	-	9.0	
Turn-On Delay Time	t _{d(on)}			-	9.6	-	
Rise Time	t _r	$V_{DD} =$	- 50 V, I _D = - 6.8 A,	-	29	-	ne
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega$, $R_D = 7.1 \Omega$, see fig. 10^b		-	21	-	- ns -
Fall Time	t _f			-	25	-	
Internal Drain Inductance	L _D		Between lead, 6 mm (0.25") from package and center of die contact		4.5	=	الم
Internal Source Inductance	L _S				7.5	-	- nH
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 5.6	_
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 22	A
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_S = -5.6 \text{ A}, V_{GS} = 0 \text{ V}^b$	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 05 °C	- 60 A dl/dt - 100 A/:-ah	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_{\rm J} = 25~{\rm ^{\circ}C}, I_{\rm F} = -6.8~{\rm A}, dI/dt = 100~{\rm A/\mu s^b}$		-	0.33	0.66	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

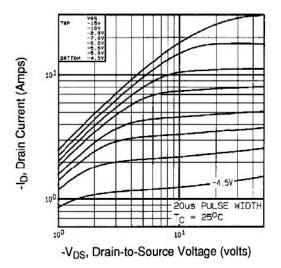


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

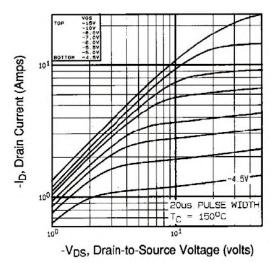
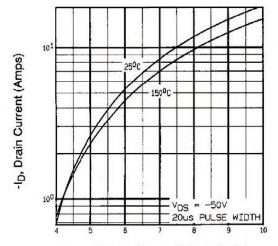


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



-VGS, Gate-to-Source Voltage (volts)

Fig. 3 - Typical Transfer Characteristics

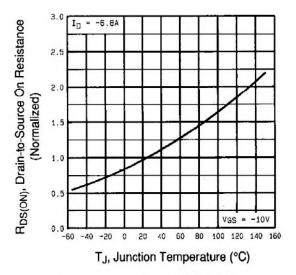


Fig. 4 - Normalized On-Resistance vs. Temperature

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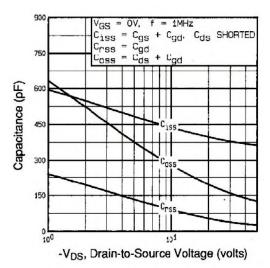


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

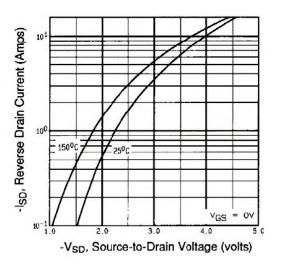


Fig. 7 - Typical Source-Drain Diode Forward Voltage

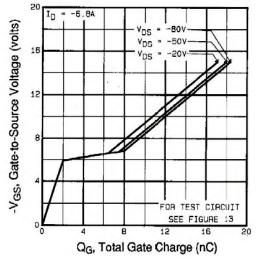


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

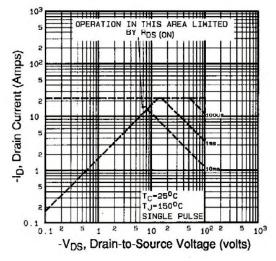


Fig. 8 - Maximum Safe Operating Area

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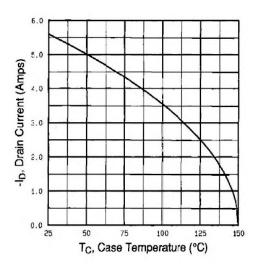


Fig. 9 - Maximum Drain Current vs. Case Temperature

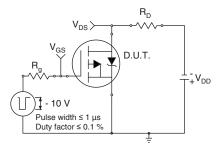


Fig. 10a - Switching Time Test Circuit

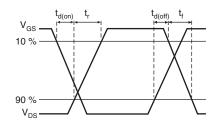


Fig. 10b - Switching Time Waveforms

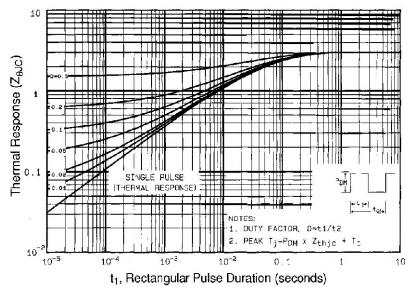


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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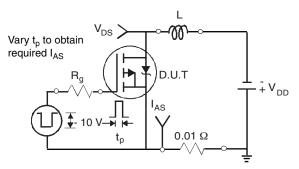


Fig. 12a - Unclamped Inductive Test Circuit

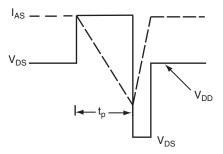


Fig. 12b - Unclamped Inductive Waveforms

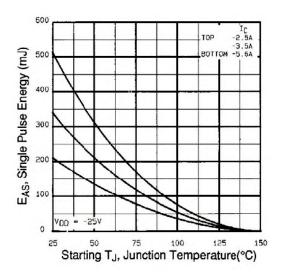


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

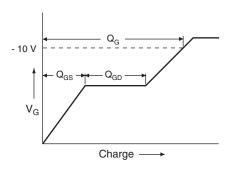


Fig. 13a - Basic Gate Charge Waveform

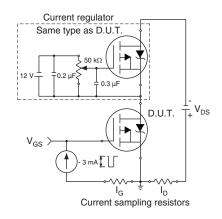
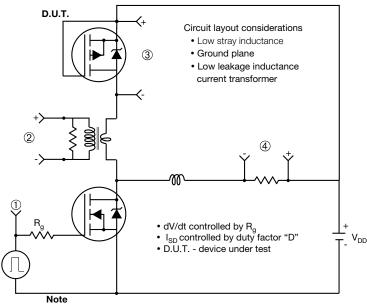


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

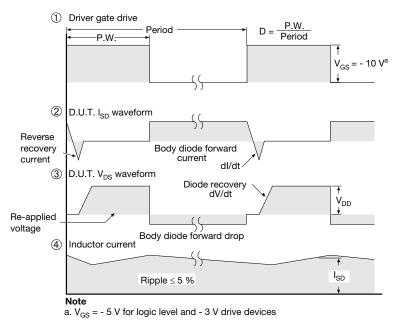
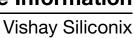


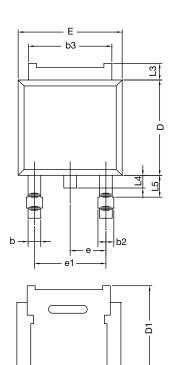
Fig. 14 - For P-Channel

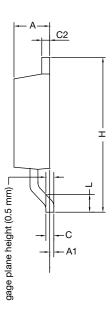
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TO-252AA Case Outline





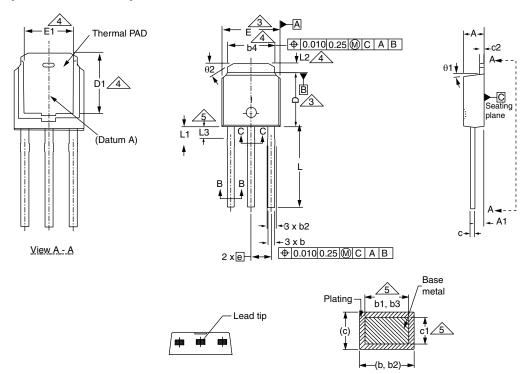
	MILLIMETERS		INC	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
e	2.28	2.28 BSC		BSC	
e1	4.56	BSC	0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

DWG: 5347 Notes

• Dimension L3 is for reference only.



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29 BSC		2.29	BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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Revision: 13-Jun-16 1 Document Number: 91000

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